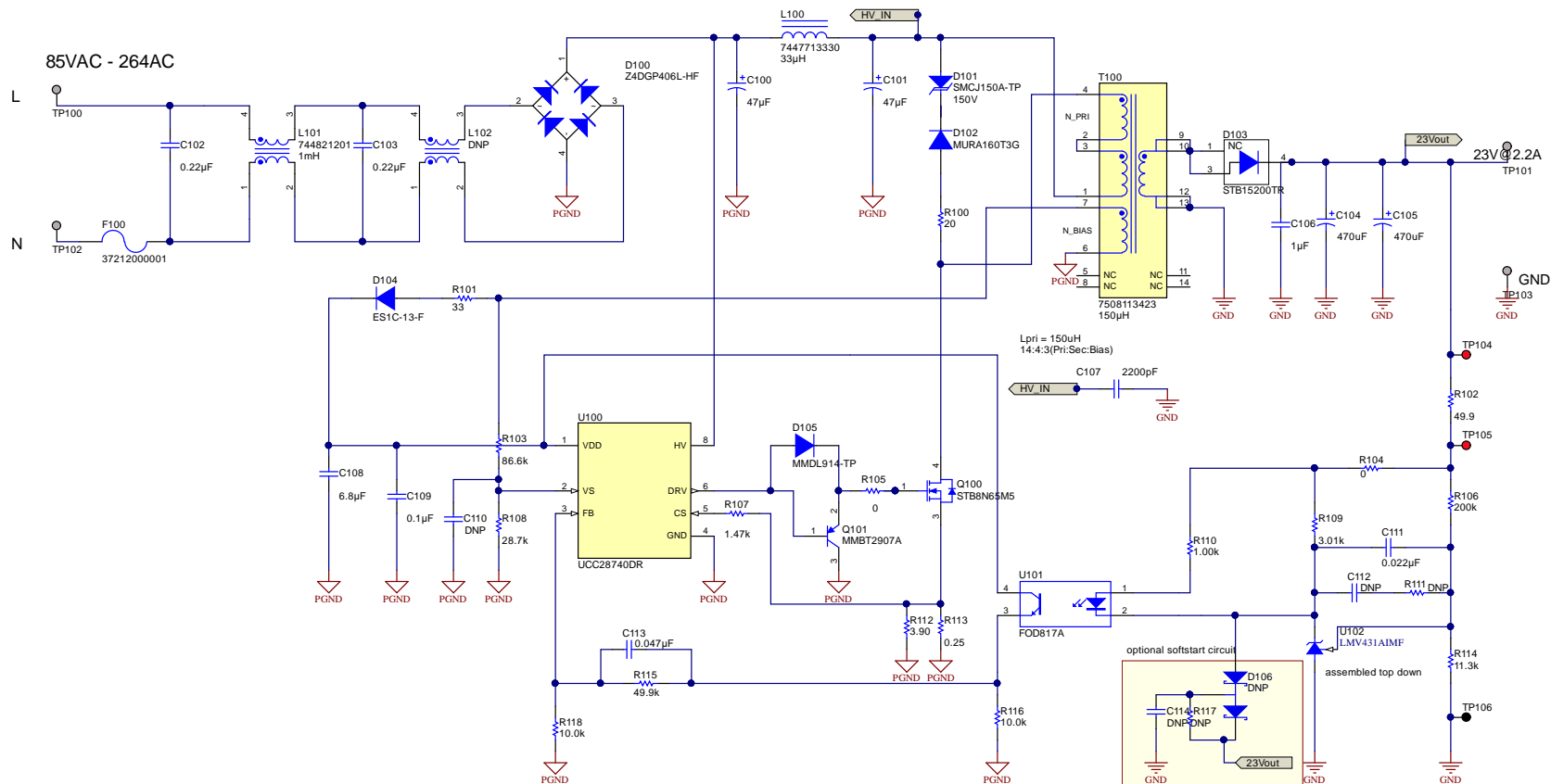



HIGH VOLTAGE!



Notes:

- DNP ="DO NOT POPULATE"
- Built on PMP30251_RevA
- U102 assembled top down

Orderable:	Designed for PUBLIC RELEASE	Mod. Date: 7/13/2017	 TEXAS INSTRUMENTS http://www.ti.com © Texas Instruments 2017
TID #: N/A	Project Title: offline 50W Flyback		
Number: PMP30251	Rev: B	Sheet Title:	
Source: Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 1 of 1	
Drawn By:	File: PMP30251_RevB_SchDoc	Size: B	
Engineer: F. Mueller	Contact: http://www.ti.com/support		

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RtnDate: PMP30251 Rev: B Ser: This: **INSTRUMENTS**
 SMCRev: Version control disabled Assembly Variant: [No Variations] Sheet 1 of 1
 Drawn By: File: PMP30251 RevB.SchDoc Size: B <http://www.ti.com>
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